

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT3743642

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MEI-LING CHEN	12/01/2015
KUAN-YU CHEN	12/01/2015
RECEIVING PARTY DATA	
Name:	PFC DEVICE HOLDINGS LIMITED
Street Address:	1/F, SHELL INDUSTRIAL BUILDING,
Internal Address:	12 LEE CHUNG STREET, CHAI WAN,
City:	HONG KONG
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15046294
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	HDLS IPR SERVICES
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ATTORNEY DOCKET NUMBER:	OP-104000757
NAME OF SUBMITTER:	PIN PIN HUANG
SIGNATURE:	/Pin Pin Huang/
DATE SIGNED:	02/17/2016
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	
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**DECLARATION AND ASSIGNMENT
FOR PATENT AND DESIGN APPLICATIONS**

**LOW-TEMPERATURE EPITAXIAL METHOD FOR MANUFACTURING BACKSIDE FIELD STOP
LAYER OF INSULATED GATE BIPOLAR TRANSISTOR (IGBT)**

(Title of Invention)

As a below named inventor, I hereby declare that:

This declaration is directed to:

The attached application,
AND/OR

United States Application Number or PCT International Application number _____,
filed on _____.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

WHEREAS **PFC Device Holdings Limited**

1/F., SHELL INDUSTRIAL BUILDING, 12 LEE CHUNG STREET, CHAI WAN,

who's address is **HONG KONG.**

hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for a good and valuable consideration received by me, I hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as I might or could have held and enjoyed the same, if this assignment had not been made.

AND I hereby agree to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND I authorize and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

**SUPPLEMENTAL SHEET FOR
DECLARATION AND ASSIGNMENT**

Signature: Mei-Ling Chen
Legal Name of
First Joint Inventor: **Mei-Ling CHEN**

Date: 2015/12/16

Signature: Kuan-Yu Chen
Legal Name of
Second Joint Inventor: **Kuan-Yu CHEN**

Date: 2015/12/11

Signature: _____
Legal Name of
Third Joint Inventor:

Date: _____

Signature: _____
Legal Name of
Fourth Joint Inventor:

Date: _____

Signature: _____
Legal Name of
Fifth Joint Inventor:

Date: _____

Signature: _____
Legal Name of
Sixth Joint Inventor:

Date: _____

Signature: _____
Legal Name of
Seventh Joint Inventor:

Date: _____

Signature: _____
Legal Name of
Eighth Joint Inventor:

Date: _____